

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L4	6005	plasma near2 hydrogen	US-PGPUB; USPAT	OR	ON	2005/09/30 09:01
L5	315	4 same microwave same (apparatus system assembly chamber)	US-PGPUB; USPAT	OR	ON	2005/09/30 08:58
L6	1359	438/474.ccls. 438/475.ccls. 438/795.ccls. 438/798.ccls.	US-PGPUB; USPAT	OR	OFF	2005/09/30 10:30
L7	140	4 and 6	US-PGPUB; USPAT	OR	ON	2005/09/30 11:48
L8	34	4 same microwave same (window dielectric aln (aluminum adj nitride) (thermal adj conduct\$8))	US-PGPUB; USPAT	OR	ON	2005/09/30 14:20
L9	2315	plasma near2 hydrogen	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/30 09:01
L10	25	9 and microwave and (window dielectric aln (aluminum adj nitride) (thermal adj conduct\$8))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/30 14:58
L11	341	plasma same microwave same (window dielectric aln (aluminum adj nitride) (thermal adj conduct\$8)) same pressure same temperature	US-PGPUB; USPAT	OR	ON	2005/09/30 09:05
L12	329	11 and (silicon substrate semiconductor wafer)	US-PGPUB; USPAT	OR	ON	2005/09/30 09:04
L13	88	11 same (dangling hydrogen "h. sub.2")	US-PGPUB; USPAT	OR	ON	2005/09/30 15:30
L14	102	plasma and microwave and (window dielectric aln (aluminum adj nitride) (thermal adj conduct\$8)) and pressure and temperature	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/30 17:21
L15	186	438/474.ccls. 438/475.ccls.	US-PGPUB; USPAT	OR	OFF	2005/09/30 10:30
L16	1	2001jp-0394546.ap,prai.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2005/09/30 15:31
L17	1	2003-559332.NRAN.	DERWENT	OR	OFF	2005/09/30 15:32
L18	155	((microwave hydrogen "h.sub.2") with plasma) and (window with (aln (aluminum adj nitride) (thermal adj conductivity)))	US-PGPUB; USPAT	OR	ON	2005/09/30 17:25

L19	30	((microwave hydrogen "h.sub.2") with plasma) same (window with (aln (aluminum adj nitride) (thermal adj conductivity)))	US-PGPUB; USPAT	OR	ON	2005/09/30 17:27
L20	8	((microwave hydrogen "h.sub.2") with plasma) and (window with (aln (aluminum adj nitride) (thermal adj conductivity)))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/30 17:25
S1	5	jp-07087250-.did. jp-07074167-.did. jp-04338194-.did.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2005/09/23 15:51
S2	2	jp-05243273-.did.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2005/09/23 15:55
S3	5	1992jp-0251435.ap,prai. 1983jp-0078970.ap,prai.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2005/09/30 08:23